ECE546 Milestone-1 Report

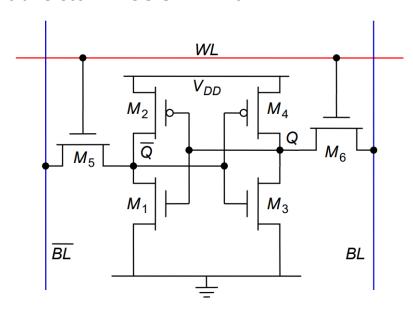
Team Members-

- 1. Vaishnavi Avadhanam-200420812
- 2. Zachary Murray-200185195
- 3. Ramachandran Sekanipuram Srikanthan-200367158

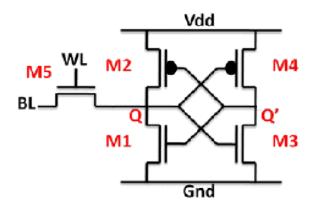
Introduction-

This project aims to build a 28 bit (32x4) Synchronous SRAM with the Inputs-Address(A<4:0>), Write data(D<3:0>), Write-Enable Bar(WENB- low indicates write) and Clock(CLK) and Outputs-Read data(Q<3:0>). The design is tested using a randomly generated set of values which are being stored and retrieved from the circuit. The Synchronous SRAM is being designed using 3nm technology. The project also focuses on developing a layout for the design. This layout is being tested using the same set of test vectors from the RC tree extracted from the layout.

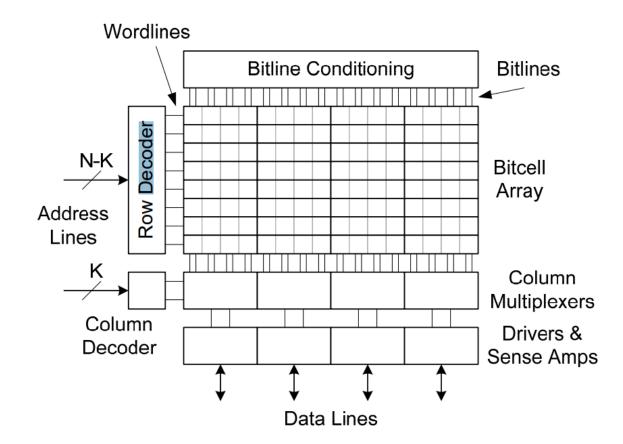
Design options being considered-Bit-cells- 6-transistor CMOS SRAM Cell



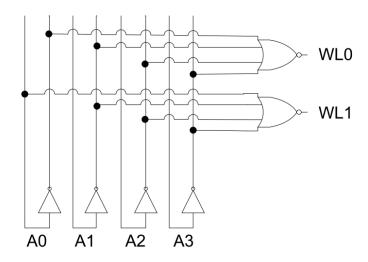
5-transistor CMOS SRAM Cell



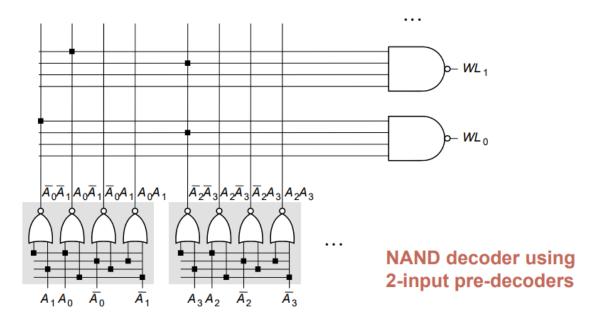
Architecture Overview-



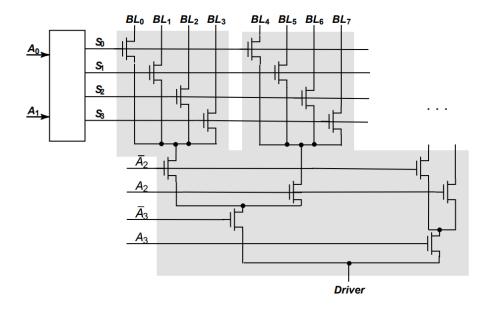
Row Decoders-Traditional Decoder



Row Decoders-Hierarchical Decoders



Column Decoder - Pre-decoded Column Decoder + Mux



Bit-line Conditioning:

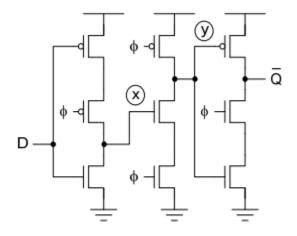
NMOS

- » Faster sensing
- » Smaller noise margin

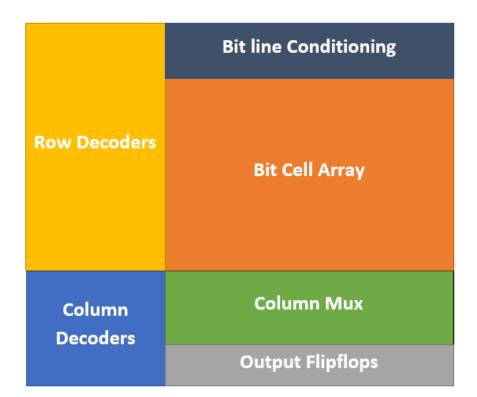


- Equalizer
 - » Better noise margin
 - Fast precharge V_{DD} & sensing BL BL BL

Flip-flops: TSPC positive edge-triggered flip flop



Rough Floor Plan



Plan of work:

Major Tasks	Assignment
Bit Cell and Cell array design and testing.	Vaishnavi Avadhanam
Row Decoders design and testing.	Zachary Murray
Column Decoders and Flip Flop design and testing.	Ramachandran Sekanipuram Srikanthan

References:

- Dachineni Bharath Satyanarayana, Kakarlapudi Pradeep, Tsr Prasad, T Ravi, 2012, A Proposed Five Transistor CMOS SRAM Cell For High Speed Applications, INTERNATIONAL JOURNAL OF ENGINEERING RESEARCH & TECHNOLOGY (IJERT) Volume 01, Issue 09 (November 2012),
- 2. Rabaey, Jan M. Digital Integrated Circuits: A Design Perspective. Prentice-Hall, 2003.